

NXP Extends its Edge-Connected Platform Portfolio with i.MX Applications Processors and Wi-Fi/Bluetooth Solutions

- The company continues to integrate its Wi-Fi/Bluetooth combo solutions across its edge processing portfolio, allowing developers to create the optimal pairing of processing with connectivity
 NNP combines its MPU and Wi-Fi/Bluetooth platform solutions within its LMX Board Support Package (BSP) to simplify and accelerate Linux and Android-based loT product development
 Connectivity modules and MPU development Nata are available now through NNPs extensive distribution network

EINDHOVEN, The Netherlands, Oct. 15, 2020 — NXP Semiconductors N.V. (NASDAC: NXPI) today amounced that its <u>Wi-EiGladoctific combos</u> and <u>UMX applications processors</u> are now supported within its <u>LMX BSP</u> software to dramatically simplify product development and provide a new level of integration as NXP continues to expand the connectivity capabilities of its <u>Eignal Years</u>—"dege computing and security platform. By integrating the NXP One Driver into the LMX board support package (BSP), NXP is providing developers with flexible and scalable platforms to help accelerate compliance, significantly shorten time-to-market and streamline Wi-Figliaetoch combo deployments. These new platforms make it possible to mix and match the right MPU and Wi-Figliaetoch combo developers with flexible and scalable platforms to help accelerate compliance, significantly shorten time-to-market and streamline Wi-Figliaetoch combo deployments. These new platforms make it possible to mix and match the right MPU and Wi-Figliaetoch Combo developers with the flower requirements of their Fit inclustriat, automatical continuation and matching the right MPU and Wi-Figliaetoch combo deployments.

Linux/Android Board Support Package (BSP)
NXP has integrated its Wi-Fi/Bluetooth drivers and comm ations stacks with i.MX applications SoCs to simplify and accelerate application development. By using the Linux/Android BSPs, developers can easily combine wireless connectivity with i.MX applications processor capabilities. The pre-integrated Wi-Fi/Bluetooth drivers have been verified and tested to deliver several useful examples, including

- IPerf utility to test device-to-device performance
 WiFiF provisioning example for easily connecting new devices to networks
 Command Line Interface (CLI) to set WiFiF parameters and network properties and experiment with various WiFiF settings/parameters
 Amazon Web Services to use as a framework for IoT products as well as device, gateway, phone, and cloud connection examples

Module Partners – The Path to Production

NXP has partnered with leading module vendors, around the world, including <u>Azurewave, Murats, Panasonic</u>, and <u>ui-blac</u> to deliver fully certified, platform-into-best module for their application and reduce the design complexity, development costs, and the time to certification. ted modules for developer designs. With additional partners being added throughout the year, NXP's broad range of module suppliers adds more flexibility for developers to cho

Availability

The LIX applications processors are the latest series of edge processing product lines to be supported by NXP's Wi-Fi and Wi-FiBlueboth combo connectivity solutions, which are now available through NXP's module partners and NXP's global mass market and distribution network, including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's module partners and NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's module partners and NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's module partners and NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's module partners and NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's module partners and NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's module partners and NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's global mass market and distribution network including Arrow, Avnet, Future, EBV, Mouser, Digkey, E14, and Wi-FiBlueboth are now available through NXP's global mass market and distribution network including Arrow, Avnet, E14, and Wi-FiBlueboth are now available through NXP's global mass market and distribution network including Arrow, Avnet, E14, and Wi-FiBlueboth are now available through NXP's global mass market and distribu

About NXP's Connectivity Portfolio

With one of the industry's broadest portfolios of wireless technologies, NXP is committed to accelerating its vision of a connected devices for IoT, industrial, auto and communic infrastructure applications—making lives easier, safer, and more convenient. Whether it's connecting people to the Internet, joining IoT devices to the cloud, or communicating with cars in new and unexpected ways, NXP's portfolio allows developers to advance their most innovative ideas with confidence. Together with our partners, we are enabling solutions that accelerate a securely connected world. Learn more at tarp commissioned with

About NVP Semiconductors

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